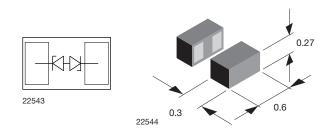
# VCUT05E1-SD0



**Vishay Semiconductors** 

# Bidirectional Symmetrical (BiSy) Single Line ESD Protection Diode in Silicon Package



### MARKING (example only)



1 = year code Open circle = month code and pin 1 XY = type code

### **DESIGN SUPPORT TOOLS**

\_\_\_\_\_



## S click logo to get started

Ultra compact CLP0603 package
Low package height < 0.3 mm</li>

**FEATURES** 

- 1-line ESD protection
- AEC-Q101 qualified available
- Working range ± 5.5 V
- Low leakage current < 0.1 μA</li>
- Low load capacitance C<sub>D</sub> < 14 pF</li>
- ESD immunity acc. IEC 61000-4-2 ± 30 kV contact discharge ± 30 kV air discharge
- Lead plating: Au (e4)
- Lead material: Ni
- Topside coating
- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





| ORDERING INFORMATION     |   |       |                |                                |                            |  |  |
|--------------------------|---|-------|----------------|--------------------------------|----------------------------|--|--|
| PART NUMBER<br>(EXAMPLE) | ENVIRONMENTAL AND QUALITY CODE  |       |                | PACKAGING CODE                 |                            |  |  |
|                          | AEC-Q101<br>QUALIFIED RoHS-COMPLIANT +<br>LEAD (Pb)-FREE TERMINATIONS |       | GOLD<br>PLATED | 15K PER 7" REEL<br>(8 mm TAPE) | ORDERING CODE<br>(EXAMPLE) |  |  |
|                          | QUALIFIED   | GREEN |                | 15K/BOX = MOQ                  |                            |  |  |
| VCUT05E1-SD0             | -   | G     | 4              | -08                            | VCUT05E1-SD0-G4-08         |  |  |
| VCUT05E1-SD0             | Н   | G     | 4              | -08                            | VCUT05E1-SD0HG4-08         |  |  |

| PACKAGE DATA             |            |                  |         |   |  |  |  |
|--------------------------|------------|------------------|---------|---|--|--|--|
| DEVICE NAME PACKAGE NAME |            | TYPE CODE WEIGHT |         | SOLDERING CONDITIONS  |  |  |  |
| VCUT05E1-SD0             | CLP0603-2L | 5D               | 0.12 mg | Peak temperature max. 260 °C<br>Reflow soldering according JEDEC <sup>®</sup> STD-020 |  |  |  |

| ABSOLUTE MAXIMUM RATINGS |  |                  |             |      |  |  |
|--------------------------|--|------------------|-------------|------|--|--|
| PARAMETER                | AMETER TEST CONDITIONS   |                  | VALUE       | UNIT |  |  |
| Peak pulse current       | acc. IEC 61000-4-5, 8/20 µs/single shot                                  | I <sub>PPM</sub> | 6           | А    |  |  |
| Peak pulse power         | Pin 1 to pin 2<br>acc. IEC 61000-4-5; $t_p = 8/20 \ \mu s$ ; single shot | P <sub>PP</sub>  | 78          | W    |  |  |
| ESD immunity             | Contact discharge acc. IEC 61000-4-2; 10 pulses                          | N                | ± 30        | kV   |  |  |
|                          | Air discharge acc. IEC 61000-4-2; 10 pulses                              | V <sub>ESD</sub> | ± 30        |      |  |  |
| Operating temperature    | Junction temperature   | TJ               | -55 to +150 | °C   |  |  |
| Storage temperature      |  | T <sub>stg</sub> | -55 to +150 | °C   |  |  |

Rev. 1.5, 03-Jan-2019

1 For technical questions, contact: <u>ESDprotection@vishay.com</u> Document Number: 85900

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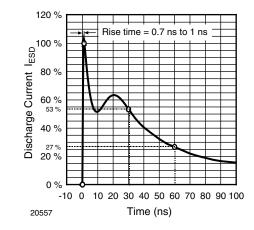
# **Vishay Semiconductors**

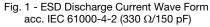
### **CUT THE SPIKES WITH VCUT05E1-SD0**

The VCUT05E1-SD0 is a Bidirectional and Symmetrical (BiSy) ESD protection device which clamps positive and negative overvoltage transients to ground. Connected between the signal or data line and the ground the VCUT05E1-SD0 offers a high isolation (low leakage current, low capacitance) within the specified working range. Due to the short leads and small package size of the tiny CLP0603 package the line inductance is very low, so that fast transients like and ESD strike can be clamped with minimal over- or undershoots.

| PARAMETER                 | TEST CONDITIONS/REMARKS   | SYMBOL  | MIN.       | TYP. | MAX. | UNIT  |
|---------------------------|---|---|------------|------|------|-------|
| Protection paths          | Number of lines which can be protected  | N <sub>channel</sub>                            | -          | -    | 1    | lines |
| Reverse stand-off voltage | Max. reverse working voltage  | c. reverse working voltage V <sub>RWM</sub> 5.5 |            | 5.5  | V    |       |
| Reverse voltage           | at I <sub>R</sub> = 0.1 μA  | V <sub>R</sub>                                  | 5.5        | -    | -    | V     |
| Reverse current           | at V <sub>RWM</sub> = 5.5 V   | l <sub>R</sub>                                  | -          | -    | 0.1  | μA    |
| Reverse breakdown voltage | at I <sub>R</sub> = 1 mA  | V <sub>BR</sub>                                 | 6.5        | 8    | 9    | V     |
| Reverse clamping voltage  | at I <sub>PP</sub> = 1 A  | V <sub>C</sub>                                  | -          | 8.8  | 10   | V     |
|                           | at I <sub>PP</sub> = I <sub>PPM</sub> = 6 A                                       | V <sub>C</sub>                                  | -          | 11   | 13   | V     |
| 0                         | at $V_R = 0 V$ ; f = 1 MHz  | CD  | -          | 13   | 14   | pF    |
| Capacitance               | at V <sub>R</sub> = 2.5 V; f = 1 MHz  | CD  | -          | 11   | -    | pF    |
| Clamping voltage          | Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$<br>$I_{TLP} = 8 \text{ A}$  | V <sub>C-TLP</sub>                              | -TLP - 9.8 |      | -    | V     |
| Clamping voltage          | Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$<br>$I_{TLP} = 16 \text{ A}$ | <sup>IS</sup> V <sub>C-TLP</sub> - 11           |            | -    | V    |       |
| Dynamic resistance        | Transmission Line Pulse (TLP); t <sub>p</sub> = 100 ns                            | R <sub>DYN</sub>                                | -          | 0.15 | -    | Ω     |

### TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)





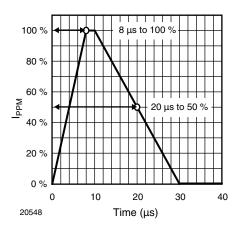


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

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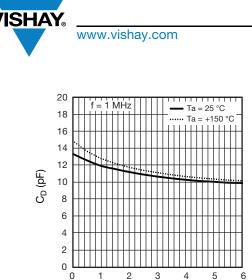


Fig. 3 - Typical Capacitance C<sub>D</sub> vs. Reverse Voltage V<sub>R</sub>

V<sub>R</sub> (V)

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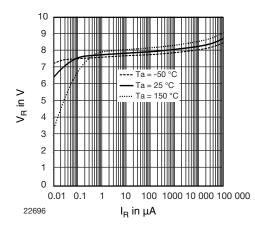
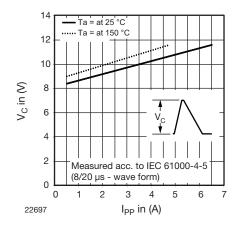
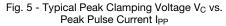


Fig. 4 - Typical Reverse Voltage V<sub>R</sub> vs. Reverse Current I<sub>R</sub>





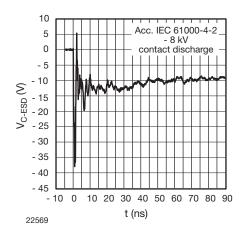


Fig. 6 - Typical Clamping Performance at 8 kV Contact Discharge acc. IEC 61000-4-2

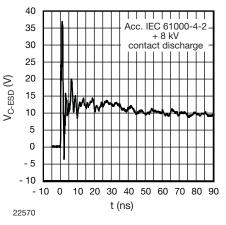


Fig. 7 - Typical Clamping Performance at 8 kV Contact Discharge acc. IEC 61000-4-2

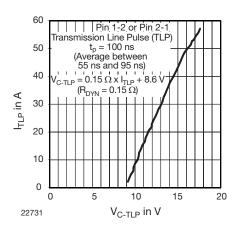


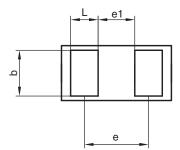
Fig. 8 - Typical Clamping Voltage at 100 ns Transmission Line Pulse (TLP)

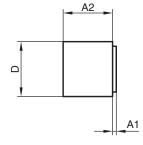
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## PACKAGE DIMENSIONS in millimeters (mils): CLP0603-2L





Package = chip dimensions in mm [mils]

|    | Millimeters |      |      | mils  |       |       |  |
|----|-------------|------|------|-------|-------|-------|--|
|    | min.        | nom. | max. | min.  | nom.  | max.  |  |
| Α  | 0.25        | 0.28 | 0.30 | 9.84  | 11.02 | 11.81 |  |
| A1 | 0.01        | 0.01 | 0.02 | 0.39  | 0.39  | 0.79  |  |
| A2 | 0.24        | 0.27 | 0.28 | 9.45  | 10.63 | 11.02 |  |
| b  | 0.22        | 0.25 | 0.28 | 8.66  | 9.84  | 11.02 |  |
| D  | 0.27        | 0.30 | 0.33 | 10.62 | 11.81 | 12.99 |  |
| E  | 0.57        | 0.60 | 0.63 | 22.44 | 23.62 | 24.80 |  |
| е  |             | 0.40 |      |       | 15.75 |       |  |
| e1 |             | 0.25 |      |       | 9.84  |       |  |
| L  | 0.12        | 0.15 | 0.18 | 4.72  | 5.91  | 7.09  |  |

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2 terminal leadless package (CLP) Document no.: S8-V-3906.04-023 (4) Created - Date: 22. Nov. 2010 Rev.8 - Date: 11. Nov. 2016

#### Footprint and soldering recommendation:

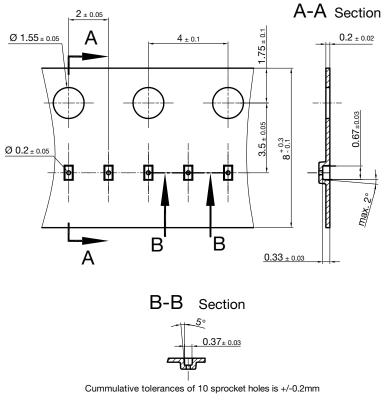
please see Application Note: www.vishay.com/doc?85917

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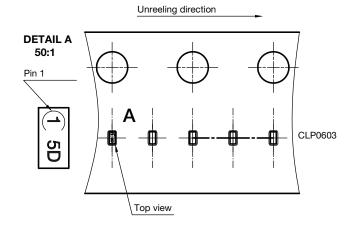
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#### CARRIER TAPE in millimeters: CLP0603-2L



22591 Document no. S8-V-3906.04-0025 (4) Created - Date: 22. Nov. 2010

### **ORIENTATION IN CARRIER CLP0603-2L**



Orientation in Carrier Tape (CLP0603) S8-V-3906.04-026 (4) 22.10.2010

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